SLLS083B - NOVEMBER 1970 - REVISED MAY 1995

- Meets or Exceeds the Requirements of ANSI Standard EIA/TIA-232-E and ITU Recommendation V.28
- Input Resistance . . . 3 kΩ to 7 kΩ Over Full EIA/TIA-232-E Voltage Range
- Input Threshold Adjustable to Meet Fail-Safe Requirements Without Using External Components
- Built-In Hysteresis for Increased Noise
 Immunity
- Inverting Output Compatible With TTL
- Output With Active Pullup for Symmetrical Switching Speeds
- Standard Supply Voltages . . . 5 V or 12 V

description

The SN75154 is a monolithic low-power Schottky line receiver designed to satisfy the requirements of the standard interface between data terminal equipment and data communication equipment as defined by ANSI Standard EIA/TIA-232-E. Other applications are for relatively short, single-line, point-to-point data transmission and for level translators. Operation is normally from a single 5-V supply; however, a built-in option allows operation from a 12-V supply without the use of additional components. The output is compatible with most TTL circuits when either supply voltage is used.

In normal operation, the threshold-control terminals are connected to the V_{CC1} terminal, even if power is being supplied via the alternate V_{CC2} terminal. This provides a wide hysteresis loop, which is the difference between the positive-going and negative-going threshold voltages. See typical characteristics. In this mode of operation, if the input voltage goes to zero, the output voltage will remain at the low or high level as determined by the previous input.

For fail-safe operation, the threshold-control terminals are open. This reduces the hysteresis loop by causing the negative-going threshold voltage to be above zero. The positive-going threshold voltage remains above zero as it is unaffected by the disposition of the threshold terminals. In the fail-safe mode, if the input voltage goes to zero or an open-circuit condition, the output will go to the high level regardless of the previous input condition.

The SN75154 is characterized for operation from 0°C to 70°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



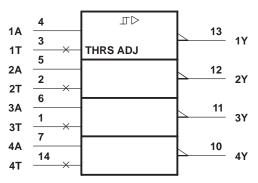
		VIEW	
3T [• 1	16	V _{CC2} V _{CC1}
2T [2	15] 4T
1T [3	14	
1A [4	13] 1Y
2A [5	12] 2Y
3A [4A [6	11] 3Y
GND	7	10] 4 î
	8	9] R1†

[†] For function of R1, see schematic

Copyright © 1995, Texas Instruments Incorporated

SLLS083B - NOVEMBER 1970 - REVISED MAY 1995

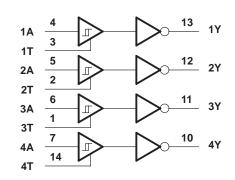
logic symbol[†]

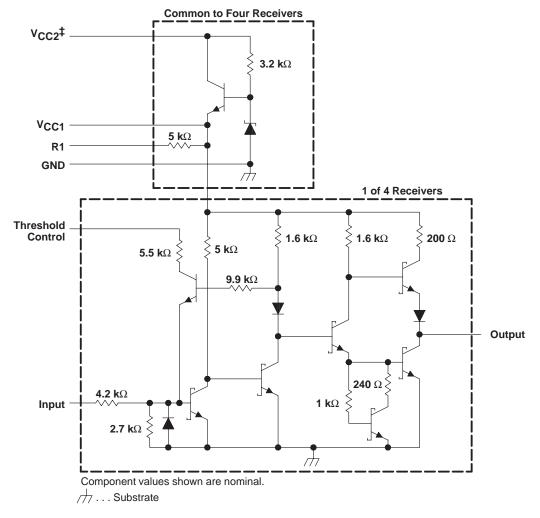


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

schematic

logic diagram (positive logic)





[‡] When V_{CC1} is used, V_{CC2} may be left open or shorted to V_{CC1}. When V_{CC2} is used, V_{CC1} must be left open or connected to the threshold control pins.



SLLS083B - NOVEMBER 1970 - REVISED MAY 1995

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Normal supply voltage, V _{CC1} (see Note 1)	
Alternate supply voltage, V _{CC2}	14 V
Input voltage, V _I	±25 V
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T _A	
Storage temperature range, T _{stg}	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: Voltage values are with respect to network GND terminal.

DISSILATION NATING TABLE											
PACKAGE	T _A ≤ 25°C POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING								
D	950 mW	7.6 mW/°C	608 mW								
N	1150 mW	9.2 mW/°C	736 mW								
NS	625 mW	5.0 mW/°C	400 mW								

DISSIPATION RATING TABLE

recommended operating conditions

	MIN	NOM	MAX	UNIT
Normal supply voltage, V _{CC1}	4.5	5	5.5	V
Alternate supply voltage, V _{CC2}	10.8	12	13.2	V
High-level input voltage, VIH (see Note 2)	3		15	V
Low-level input voltage, VIL (see Note 2)	-15		-3	V
High-level output current, I _{OH}			-400	μΑ
Low-level output current, IOL			16	mA
Operating free-air temperature, T _A	0		70	°C

NOTE 2: The algebraic convention, where the less positive (more negative) limit is designated as minimum, is used in this data sheet for logic and threshold levels only, e.g., when 0 V is the maximum, the minimum limit is a more negative voltage.



SLLS083B - NOVEMBER 1970 - REVISED MAY 1995

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST FIGURE	TEST COND	DITIONS	MIN	түр†	МАХ	UNIT
\/	Positive-going input	Normal operation	1			0.8	2.2	3	V
VIT+	threshold voltage	Fail-safe operation				0.8	2.2	3	v
\/. _	Negative-going input	Normal operation	1			-3	-1.1	0	V
VIT-	threshold voltage	Fail-safe operation				0.8	1.4	3	v
\ <i>\</i> .	Hysteresis voltage	Normal operation	1			0.8	3.3	6	V
V _{hys}	$(V_{IT+} - V_{IT-})$	Fail-safe operation				0	0.8	2.2	v
VOH	High-level output voltage		1	I _{OH} = -400 μA		2.4	3.5		V
VOL	Low-level output voltage		1	I _{OL} = 16 mA			0.29	0.4	V
			$\Delta V_I = -25 \text{ V to } -1$	4 V	3	5	7	7	
			$\Delta V_{I} = -14 \text{ V to } -3$	S V	3	5	7		
ri	Input resistance	2	$\Delta V_{I} = -3 \text{ V to } 3 \text{ V}$		3	6	8	kΩ	
			$\Delta V_I = 3 \text{ V to } 14 \text{ V}$		3	5	7	1122	
			ΔV_{I} = 14 V to 25 V	/	3	5	7		
V _{I(open)}	Open-circuit input voltage		3	$I_I = 0$		0	0.2	2	V
los	Short-circuit output current [‡]		4	V _{CC1} = 5.5 V,	$V_{I} = -5 V$	-10	-20	-40	mA
ICC1	Supply current from V _{CC1}		5	V _{CC1} = 5.5 V,	T _A = 25°C		20	35	mA
ICC2	Supply current from V _{CC2}		V _{CC2} = 13.2 V,	T _A = 25°C		23	40	mA	

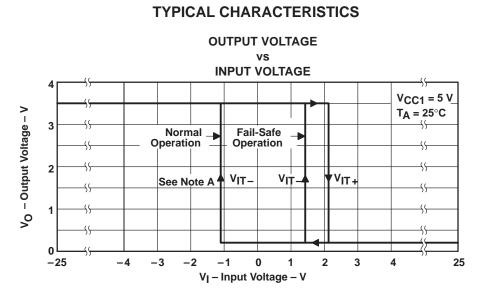
[†] All typical values are at $V_{CC1} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$. [‡] Not more than one output should be shorted at a time.

switching characteristics, V_{CC1} = 5 V, T_A = 25°C, N = 10

	PARAMETER	TEST FIGURE	TEST CO	NDITIONS	MIN	TYP	МАХ	UNIT	
^t PLH	Propagation delay time, low- to high-level output					11		ns	
^t PHL	Propagation delay time, high- to low-level output	6	$C_{1} = 50 \text{ pc}$	R ₁ = 390 Ω		8		ns	
t _{TLH}	Transition time, low- to high-level output	0	0	C _L = 50 pF,	KL = 390 32		7		ns
^t THL	Transition time, high- to low-level output					2.2		ns	



SLLS083B - NOVEMBER 1970 - REVISED MAY 1995



NOTE A: For normal operation, the threshold controls are connected to V_{CC1}. For fail-safe operation, the threshold controls are open.

Figure 1



SLLS083B - NOVEMBER 1970 - REVISED MAY 1995

PARAMETER MEASUREMENT INFORMATION

dc test circuits[†]

TEST TABLE										
TEST	MEASURE	Α	Т	Y	V _{CC1}	V _{CC2}				
Open circuit input (feil acto)	VOH	Open	Open	ЮН	4.5 V	Open				
Open-circuit input (fail safe)	VOH	Open	Open	ЮН	Open	10.8 V				
	VOH	0.8 V	Open	ЮН	5.5 V	Open				
V _{IT +} min, V _{IT –} min (fail safe)	VOH	0.8 V	Open	ЮН	Open	13.2 V				
	VOH	Note A	VCC1	ЮН	5.5 V and T	Open				
V _{IT +} min (normal)	Voh	Note A	VCC1	ЮН	Т	13.2 V				
	VOH	-3 V	V _{CC1}	ЮН	5.5 V and T	Open				
V _{IL} max, V _{IT +} min (normal)	VOH	-3 V	V _{CC1}	ЮН	Т	13.2 V				
	VOL	3 V	Open	IOL	4.5 V	Open				
VIH min, VIT+ max, VIT_ max (fail safe)	VOL	3 V	Open	IOL	Open	10.8 V				
	VOL	3 V	VCC1	IOL	4.5 V and T	Open				
VIH min, VIT + max (normal)	VOL	3 V	VCC1	IOL	Т	10.8 V				
	VOL	Note B	VCC1	IOL	5.5 V and T	Open				
V _{IT} _max (normal)	VOL	Note B	V _{CC1}	IOL	Т	13.2 V				

NOTES: A. Momentarily apply -5 V, then 0.8 V.

B. Momentarily apply 5 V, then GND.

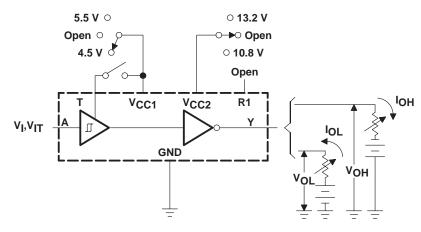


Figure 2. V_{IH} , V_{IL} , V_{IT+} , V_{IT-} , V_{OH} , V_{OL}

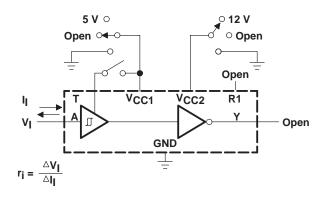
[†] Arrows indicate actual direction of current flow. Current into a terminal is a positive value.



SLLS083B - NOVEMBER 1970 - REVISED MAY 1995

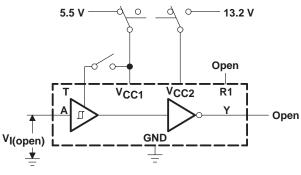
PARAMETER MEASUREMENT INFORMATION

dc test circuits[†] (continued)



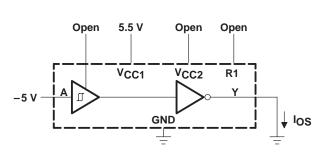
TEST TABLE										
Т	V _{CC2}									
Open	5 V	Open								
Open	GND	Open								
Open	Open	Open								
VCC1	T and 5 V	Open								
GND	GND	Open								
Open	Open	12 V								
Open	Open	GND								
VCC1	Т	12 V								
VCC1	Т	GND								
VCC1	Т	Open								

Figure 3. Input Resistance



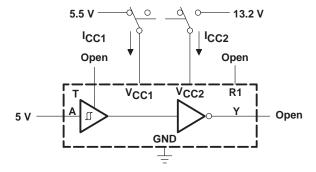
	TEST TABLE	
т	V _{CC1}	V _{CC2}
Open	5.5 V	Open
VCC1	5.5 V	Open
Open	Open	13.2 V
VCC1	Т	13.2 V





Each output is tested separately.

Figure 5. Output Short-Circuit Current



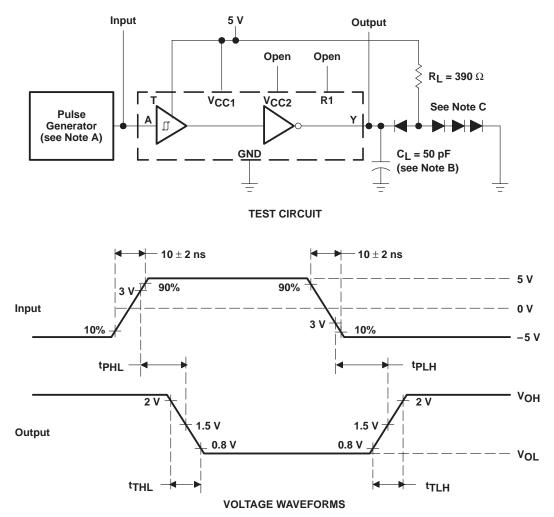
All four line receivers are tested simultaneously.

Figure 6. Supply Current

[†] Arrows indicate actual direction of current flow. Current into a terminal is a positive value.



SLLS083B - NOVEMBER 1970 - REVISED MAY 1995



PARAMETER MEASUREMENT INFORMATION

- NOTES: A. The pulse generator has the following characteristics: $Z_O = 50 \Omega$, $t_W \le 200$ ns, duty cycle $\le 20\%$.
 - B. CL includes probe and jig capacitance.
 - C. All diodes are 1N3064.

Figure 6. Test Circuit and Voltage Waveforms



IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2007, Texas Instruments Incorporated

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN75154D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154N	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75154NE4	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75154NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI



PACKAGE OPTION ADDENDUM

4-Jun-2007

to Customer on an annual basis.

TEXAS INSTRUMENTS www.ti.com

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*A	l dimensions are nominal												
	Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	SN75154DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
	SN75154NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



PACKAGE MATERIALS INFORMATION

19-Mar-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75154DR	SOIC	D	16	2500	333.2	345.9	28.6
SN75154NSR	SO	NS	16	2000	346.0	346.0	33.0

MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AC.



D(R-PDSO-G16)



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Refer to IPC7351 for alternate board design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Clocks and Timers	www.ti.com/clocks	Digital Control	www.ti.com/digitalcontrol
Interface	interface.ti.com	Medical	www.ti.com/medical
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
RFID	www.ti-rfid.com	Telephony	www.ti.com/telephony
RF/IF and ZigBee® Solutions	www.ti.com/lprf	Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2008, Texas Instruments Incorporated